- Three-State Outputs Interface Directly with System Bus
- 'LS257B and 'LS258B Offer Three Times the Sink-Current Capability of the Original 'LS257 and 'LS258
- Same Pin Assignments as SN54LS157, SN74LS157, SN54S157, SN74S157, and SN54LS158, SN74LS158, SN54S158, SN74S158
- Provides Bus Interface from Multiple Sources in High-Performance Systems

	AVERAGE PROPAGATION	TYPICAL
	DELAY FROM	POWER
	DATA INPUT	DISSIPATIONT
'LS257B	9 ns	55 mW
'LS258B	9 ns	55 mW
'S257	4.8 ns	320 mW
'S258	4 ns	280 mW

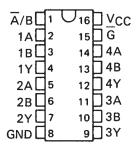
[†]Off state (worst case)

description

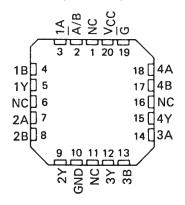
These devices are designed to multiplex signals from four-bit data sources to four-output data lines in busorganized systems. The 3-state outputs will not load the data lines when the output control pin (\overline{G}) is at a high-logic level.

Series 54LS and 54S are characterized for operation over the full military temperature range of -55° C to 125°C; Series 74LS and 74S are characterized for operation from 0°C to 70°C.

SN54LS257B, SN54S257, SN54LS258B, SN54S258 . . . J OR W PACKAGE SN74LS257B, SN74S257, SN74LS258B, SN74S258 . . . D OR N PACKAGE (TOP VIEW)



SN54LS257B, SN54S257, SN54LS258B, SN54S258 . . . FK PACKAGE (TOP VIEW)



NC-No internal connection.

FUNCTION TABLE

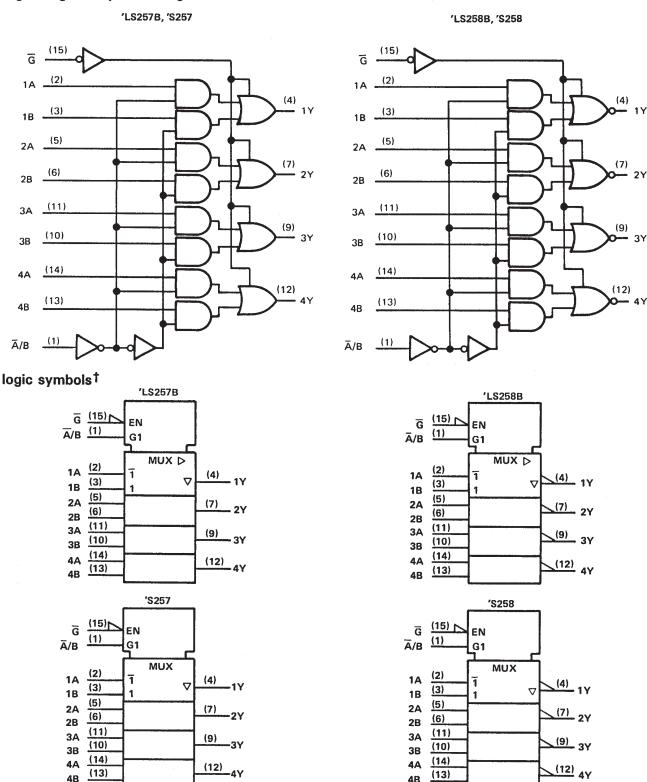
	INPUTS			OUTPUT Y			
OUTPUT CONTROL	SELECT	А	В	'LS257B 'S257	'LS258B 'S258		
Н	Х	Х	Х	Z	Z		
L	L,	L	Х	L	Н		
L	L	Н	Х	Н	L		
L	Н	Х	L,	L	Н		
L	Н	Х	Н	Н	L		

H = high level, L = low level, X = irrelevant,

Z = high Impedance (off)



logic diagrams (positive logic)



[†]These symbols are in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12. Pin numbers shown are for D, J, N, and W packages.

(12)

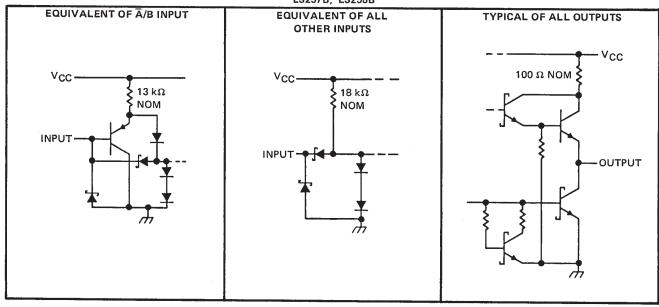
(13)4B



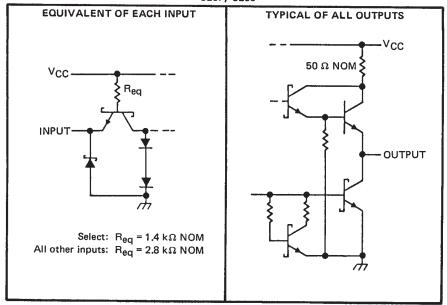
(13)

schematics of inputs and outputs

'LS257B, 'LS258B



'S257, 'S258



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (see Note 1)	7 V
Input voltage: 'LS257B, 'LS258B Circuits	
'S257, 'S258 Circuits	5.5 V
Off-state output voltage	5.5 V
Operating free-air temperature range: SN54LS', SN54S' Circuits	
SN74LS', SN74S' Circuits	
Storage temperature range	

NOTE 1: Voltage values are with respect to network ground terminal.



SN54LS257B, SN54LS258B, SN54S257, SN54S258 SN74LS257B, SN74LS258B, SN74S257, SN74S258 QUADRUPLE 2-LINE TO 1-LINE DATA SELECTORS/MULTIPLEXERS

SDLS148 - OCTOBER 1976 - REVISED MARCH 1988

recommended operating conditions

		SN54LS	S'		UNIT		
	MIN	NOM	MAX	MIN	NOM	MAX	UNIT
V _{CC} Supply voltage	4.5	5	5.5	4.75	5	5.25	V
V _{IH} High-level input voltage	2			2			V
VIL Low-level input voltage			0.7			0.8	V
IOH High-level output current		··	– 1			- 2.6	mA
IOL Low-level output current			12			24	mA
TA Operating free-air temperature	55		125	0		70	°c

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

i ,	PARAMETER	TE	ST CONDITION	ust		SN54LS	3'		SN74LS	3'	
		• •	ST CONDITION	40.	MIN	TYP‡	MAX	MIN	TYP‡	MAX	UNIT
VIK		V _{CC} = MIN,	1 ₁ = 18 mA				- 1.5			1.5	V
VOH		V _{CC} = MIN, I _{OH} = MAX	$V_{IH} = 2 V$,	VIL = MAX,	2.4	3.4		2.4	3.1		٧
VOL		VCC = MIN,	V _{IH} = 2 V,	I _{OL} = 12 mA		0.25	0.4		0.25	0.4	
- OL		VIL = MAX,		I _{OL} = 24 mA					0.35	0.5	V
lozh_		V _{CC} = MAX,	V _{IH} = 2 V,	V _O = 2.7 V			20			20	μΑ
lozL		V _{CC} - MAX,	$V_{1H} = 2 V$	V _O = 0.4 V			20			- 20	μΑ
11		V _{CC} = MAX,	V1 = 7 V				0.1			0.1	mA
1H		V _{CC} = MAX,	V1 = 2.7 V				20			20	μΑ
ll L		V _{CC} = MAX,	V _I = 0.4 V				- 0.4			- 0.4	mA
los §		V _{CC} = MAX,			- 30		- 130	30		- 130	mA
	All outputs high					8	12	1	8	12	
	All outputs low			'LS257B		12	18		12	18	1
laa	All outputs off	V	011 0			13	19		13	19]
lcc	All outputs high	V _{CC} = MAX,	See Note 2			6	9		6	9	mA
	All outputs low			'LS258B		10	15		10	15	1
	All outputs off					11	16		11	16	

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions. ‡ All typical values are at V_{CC} = 5 V, T_A = 25°C.

switching characteristics, VCC = 5 V, $T_A = 25^{\circ}$ C, $R_L = 667 \Omega$

PARAMETER	FROM	то	TEST CONDITIONS			'LS257	В		'LS258	В				
TAIN METER	(INPUT)	(OUTPUT)	1231 001	IDITIONS	MIN	TYP	MAX	MIN	TYP	MAX	דומט			
^t PLH	Data	Any			8	13		7	12					
^t PHL	Data	Ally		See Note 3		10	15		11	17	ns			
^t PLH	Select	Anv	C _L = 45 pF,			16	21		14	21				
^t PHL		Any	Ally	Ally		C[- 45 μ-,	See Note S		17	24		19	24	ns
^t PZH	Output	Any					15	30		15	30			
^t PZL	Control	Ally				19	30		20	30	ns			
^t PHZ	Output	Any	C. = = = =	Con Note 2		18	30		18	30				
t _{PLZ}	Control	"	$C_L = 5 pF$,	See Note 3		16	25		16	25	ns			

 $[\]P_{\text{tpLH}}$ = propagation delay time, low-to-high-level output

tpzL = output enable time to low level

tpHZ = output disable time from high level

tpLZ = output disable time from low level



[§]Not more than one output should be shorted at a time and duration of the short-circuit should not exceed one second.

NOTE 2: ICC is measured with all outputs open and all possible inputs grounded while achieving the stated output conditions.

tpHL = propagation delay time, high-to-low-level output

tpzH = output enable time to high level

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

recommended operating conditions

		SN54S'			UNIT		
	MIN	NOM	MAX	MIN	NOM	MAX	CIVIT
Supply voltage, V _{CC}	4.5	5	5.5	4.75	5	5.25	٧
High-level output current, IOH			-2			6.5	mΑ
Low-level output current, IOL			20			20	mA
Operating free-air temperature, TA	55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

							'S257		'S258			UNIT
	PARAME'	TER	TEST	CONDITIONS		MIN	TYP [‡]	MAX	MIN	TYP [‡]	MAX	UNII
VIH	High-level input	voltage				2			2			٧
VIL	Low-level input				1			0.8			0.8	٧
VIK	Input clamp vol		V _{CC} = MIN,	I _I = -18 mA				1.2			-1.2	٧
			V _{CC} = MIN, V _{IL} = 0.8 V,	V _{IH} = 2 V, I _{OH} = -1 mA	SN74S'	2.7			2.7			V
VOH	High-level output voltage		V _{CC} = MIN,		SN54S'	2.4	3.4		2.4	3.4		ľ
			$V_{IL} = 0.8 V$	IOH = MAX	SN74S'	2.4	3.2		2.4	3.2		
VOL	Low-level outpu	ut voltage	V _{CC} = MIN, V _{IL} = 0.8 V,	V _{1H} = 2 V, I _{OL} = 20 mA				0.5			0.5	٧
IOZH	Off-state output	· ·	V _{CC} = MAX, V _O = 2.4 V	V _{IH} = 2 V,				50			50	μΑ
IOZL	Off-state output	•	V _{CC} = MAX, V _O = 0.5 V	V _{IH} = 2 V,				-50			-50	μА
l _l	Input current a	t maximum	V _{CC} = MAX,	V _I = 5.5 V				1			1	mA
	High-level	Sinput		0.7.1				100			100	μΑ
ΉН	input current	Any other	V _{CC} = MAX,	V ₁ = 2.7 V				50			50] "
	Low-level	S input						-4			-4	mA
HL	input current	Any other	V _{CC} = MAX	V = 0.5 V				-2			-2	1111/4
los	Short-circuit ou	itput current §	V _{CC} = MAX			-40		-100	-40		-100	mA
		All outputs high					44	68		36	56	1
ICC	Supply current	All outputs low	VCC = MAX,	See Note 2			60	93		52	81	mA
		All outputs off]				64	99		56	87	

[†]For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

 ‡ All typical values are at $V_{CC} = 5 \text{ V}$, $T_{A} = 25^{\circ}\text{C}$.

NOTE 2: ICC is measured with all outputs open and all possible inputs grounded while achieving the stated output conditions.

switching characteristics, VCC = 5 V, $TA = 25^{\circ}\text{C}$, $RL = 280 \Omega$

	FROM	то	TEST		'S257			'S258		UNIT
PARAMETER¶	(INPUT)	(OUTPUT)	CONDITIONS	MIN	TYP	MAX	MIN	TYP	MAX	UNIT
tPLH	5-1-	A ===			5	7.5		4	6	ns
tPHL	Data	Any			4.5	6.5		4	6] '''
tPLH			$C_L = 15 pF$,		8.5	15		8	12	ns
tPHL	Select	Any	See Note 3		8.5	15		7.5	12	113
tPZH	Output	_	1		13	19.5		13	19.5	ns
tPZL	Control	Any			14	21		14	21	1 "
tPHZ	Output	1	$C_L = 5 pF$,		5.5	8.5		5.5	8.5	
tPLZ	Control	Any	See Note 3		9	14		9	14	ns

¶f_{max} = Maximum clock frequency

tpLH = propagation delay time, low-to-high-level output

tpHL = propagation delay time, high-to-low-level output

tpZH = output enable time to high level

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

 $t_{PZL} \equiv$ output enable time to low level $t_{PHZ} \equiv$ output disable time from high level

tpLZ ≡ output disable time from low level



Not more than one output should be shorted at a time and duration of the short-circuit should not exceed one second.





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PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
7603701EA	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	7603701EA SNJ54LS257BJ	Samples
7603701FA	ACTIVE	CFP	W	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	7603701FA SNJ54LS257BW	Samples
7603701FA	ACTIVE	CFP	W	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	7603701FA SNJ54LS257BW	Samples
7603801EA	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	7603801EA SNJ54LS258BJ	Samples
7603801EA	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	7603801EA SNJ54LS258BJ	Samples
8002301EA	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	8002301EA SNJ54S258J	Samples
8002301EA	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	8002301EA SNJ54S258J	Samples
8002301FA	ACTIVE	CFP	W	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	8002301FA SNJ54S258W	Samples
8002301FA	ACTIVE	CFP	W	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	8002301FA SNJ54S258W	Samples
JM38510/07906BEA	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 07906BEA	Samples
JM38510/07906BEA	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 07906BEA	Samples
JM38510/07906BFA	ACTIVE	CFP	W	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 07906BFA	Samples
JM38510/07906BFA	ACTIVE	CFP	W	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 07906BFA	Samples
JM38510/30906B2A	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30906B2A	Samples
JM38510/30906B2A	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30906B2A	Samples
JM38510/30906BEA	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30906BEA	Samples





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Orderable Device	Status	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
JM38510/30906BEA	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30906BEA	Samples
JM38510/30906BFA	ACTIVE	CFP	W	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30906BFA	Samples
JM38510/30906BFA	ACTIVE	CFP	W	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30906BFA	Samples
M38510/07906BEA	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 07906BEA	Samples
M38510/07906BEA	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 07906BEA	Samples
M38510/07906BFA	ACTIVE	CFP	W	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 07906BFA	Samples
M38510/07906BFA	ACTIVE	CFP	W	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 07906BFA	Samples
M38510/30906B2A	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30906B2A	Samples
M38510/30906B2A	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30906B2A	Samples
M38510/30906BEA	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30906BEA	Samples
M38510/30906BEA	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30906BEA	Samples
M38510/30906BFA	ACTIVE	CFP	W	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30906BFA	Samples
M38510/30906BFA	ACTIVE	CFP	W	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30906BFA	Samples
SN54LS257BJ	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54LS257BJ	Samples
SN54LS257BJ	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54LS257BJ	Samples
SN54LS258BJ	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54LS258BJ	Samples
SN54LS258BJ	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54LS258BJ	Samples



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Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Sample
SN54S257J	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54S257J	Sample
SN54S257J	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54S257J	Sample
SN74LS257BD	ACTIVE	SOIC	D	16	40	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS257B	Sampl
SN74LS257BD	ACTIVE	SOIC	D	16	40	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS257B	Sampl
SN74LS257BDR	ACTIVE	SOIC	D	16	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS257B	Sampl
SN74LS257BDR	ACTIVE	SOIC	D	16	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS257B	Sampl
SN74LS257BN	ACTIVE	PDIP	N	16	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS257BN	Samp
SN74LS257BN	ACTIVE	PDIP	N	16	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS257BN	Sampl
SN74LS257BNSR	ACTIVE	SO	NS	16	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS257B	Samp
SN74LS257BNSR	ACTIVE	SO	NS	16	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS257B	Samp
SN74LS258BD	ACTIVE	SOIC	D	16	40	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS258B	Sampl
SN74LS258BD	ACTIVE	SOIC	D	16	40	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS258B	Samp
SN74LS258BDR	ACTIVE	SOIC	D	16	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS258B	Sampl
SN74LS258BDR	ACTIVE	SOIC	D	16	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS258B	Sampl
SN74LS258BN	ACTIVE	PDIP	N	16	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS258BN	Samp
SN74LS258BN	ACTIVE	PDIP	N	16	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS258BN	Samp
SN74S257N	ACTIVE	PDIP	N	16	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74S257N	Samp
SN74S257N	ACTIVE	PDIP	N	16	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74S257N	Samp
SNJ54LS257BFK	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS 257BFK	Sampl
SNJ54LS257BFK	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS 257BFK	Samp





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Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
SNJ54LS257BJ	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	7603701EA SNJ54LS257BJ	Samples
SNJ54LS257BJ	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	7603701EA SNJ54LS257BJ	Samples
SNJ54LS257BW	ACTIVE	CFP	W	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	7603701FA SNJ54LS257BW	Samples
SNJ54LS257BW	ACTIVE	CFP	W	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	7603701FA SNJ54LS257BW	Samples
SNJ54LS258BJ	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	7603801EA SNJ54LS258BJ	Samples
SNJ54LS258BJ	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	7603801EA SNJ54LS258BJ	Samples
SNJ54S257J	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54S257J	Samples
SNJ54S257J	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54S257J	Samples
SNJ54S257W	ACTIVE	CFP	W	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54S257W	Samples
SNJ54S257W	ACTIVE	CFP	W	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54S257W	Samples
SNJ54S258J	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	8002301EA SNJ54S258J	Samples
SNJ54S258J	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	8002301EA SNJ54S258J	Samples
SNJ54S258W	ACTIVE	CFP	W	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	8002301FA SNJ54S258W	Samples
SNJ54S258W	ACTIVE	CFP	W	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	8002301FA SNJ54S258W	Samples

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.



PACKAGE OPTION ADDENDUM

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(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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OTHER QUALIFIED VERSIONS OF SN54LS257B, SN54LS258B, SN54S257, SN74LS257B, SN74LS258B, SN74S257:

- Catalog: SN74LS257B, SN74LS258B, SN74S257
- Military: SN54LS257B, SN54LS258B, SN54S257

NOTE: Qualified Version Definitions:

- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications

PACKAGE MATERIALS INFORMATION

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TAPE AND REEL INFORMATION





	Dimension designed to accommodate the component width
	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter	Reel Width	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74LS257BDR	SOIC	D	16	2500	(mm) 330.0	W1 (mm) 16.4	6.5	10.3	2.1	8.0	16.0	Q1
SN74LS257BNSR	SO	NS	16	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1
SN74LS258BDR	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1

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*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm) Width (mm)		Height (mm)	
SN74LS257BDR	SOIC	D	16	2500	333.2	345.9	28.6	
SN74LS257BNSR	SO	NS	16	2000	853.0	449.0	35.0	
SN74LS258BDR	SOIC	D	16	2500	333.2	345.9	28.6	

W (R-GDFP-F16)

CERAMIC DUAL FLATPACK



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only.
- E. Falls within MIL STD 1835 GDFP2-F16



14 LEADS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



FK (S-CQCC-N**)

LEADLESS CERAMIC CHIP CARRIER

28 TERMINAL SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a metal lid.
- D. Falls within JEDEC MS-004



D (R-PDS0-G16)

PLASTIC SMALL OUTLINE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AC.



D (R-PDSO-G16)

PLASTIC SMALL OUTLINE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



MECHANICAL DATA

NS (R-PDSO-G**)

14-PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



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